



## LM26 SOT-23, $\pm 3^{\circ}\text{C}$ Accurate, Factory-Preset Thermostat

### 1 Features

- Internal Comparator With Pin Programmable  $2^{\circ}\text{C}$  or  $10^{\circ}\text{C}$  Hysteresis
- No External Components Required
- Open-Drain or Push-Pull Digital Output; Supports CMOS Logic Levels
- Internal Temperature Sensor With  $V_{\text{TEMP}}$  Output Pin
- $V_{\text{TEMP}}$  Output Allows After-Assembly System Testing
- Internal Voltage Reference and DAC for Trip-Point Setting
- Currently Available in 5-pin SOT-23 Plastic Package
- Excellent Power Supply Noise Rejection
- UL Recognized Component 
- Key Specifications
  - Power Supply Voltage 2.7 V to 5.5 V
  - Power Supply Current  
40  $\mu\text{A}$  (Maximum) 16  $\mu\text{A}$  (Typical)
  - Hysteresis Temperature  $2^{\circ}\text{C}$  or  $10^{\circ}\text{C}$  (Typical)

### 2 Applications

- Microprocessor Thermal Management
- Appliances
- Portable Battery Powered Systems
- Fan Control
- Industrial Process Control
- HVAC Systems
- Remote Temperature Sensing
- Electronic System Protection

### 3 Description

The LM26 is a precision, single digital-output, low-power thermostat comprised of an internal reference, DAC, temperature sensor and comparator. Utilizing factory programming, it can be manufactured with different trip points as well as different digital output functionality. The trip point ( $T_{\text{OS}}$ ) can be preset at the factory to any temperature in the range of  $-55^{\circ}\text{C}$  to  $110^{\circ}\text{C}$  in  $1^{\circ}\text{C}$  increments. The LM26 has one digital output ( $\text{OS}/\overline{\text{OS}}/\text{US}/\overline{\text{US}}$ ), one digital input ( $\text{HYST}$ ) and one analog output ( $V_{\text{TEMP}}$ ). The digital output stage can be preset as either open-drain or push-pull. In addition, it can be factory programmed to be active HIGH or LOW. The digital output can be factory programmed to indicate an over temperature shutdown event ( $\text{OS}$  or  $\overline{\text{OS}}$ ) or an under temperature shutdown event ( $\text{US}$  or  $\overline{\text{US}}$ ). When preset as an overtemperature shutdown ( $\overline{\text{OS}}$ ) it will go LOW to indicate that the die temperature is over the internally preset  $T_{\text{OS}}$  and go HIGH when the temperature goes below ( $T_{\text{OS}} - T_{\text{HYST}}$ ). Similarly, when preprogrammed as an undertemperature shutdown ( $\text{US}$ ) it will go HIGH to indicate that the temperature is below  $T_{\text{US}}$  and go LOW when the temperature is above ( $T_{\text{US}} + T_{\text{HYST}}$ ). The typical hysteresis,  $T_{\text{HYST}}$ , can be set to  $2^{\circ}\text{C}$  or  $10^{\circ}\text{C}$  and is controlled by the state of the  $\text{HYST}$  pin. A  $V_{\text{TEMP}}$  analog output provides a voltage that is proportional to temperature and has a  $-10.82$  mV/ $^{\circ}\text{C}$  output slope.

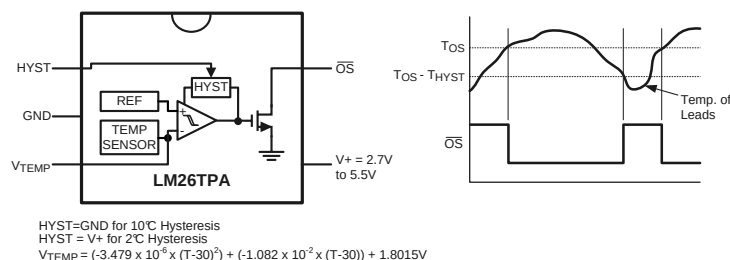
Available parts are detailed in the [Device Comparison Table](#). For other part options, contact a Texas Instruments Distributor or Sales Representative for information on minimum order qualification. The LM26 is currently available in a 5-lead SOT-23 package.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)          |
|-------------|------------|--------------------------|
| LM26        | SOT-23 (5) | 2.90 mm $\times$ 1.60 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### LM26CIM5-TPA Simplified Block Diagram and Connection Diagram



The LM26CIM5-TPA has a fixed trip point of  $85^{\circ}\text{C}$ . For other trip point and output function availability, please see the [Device Comparison Table](#) or contact Texas Instruments.



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

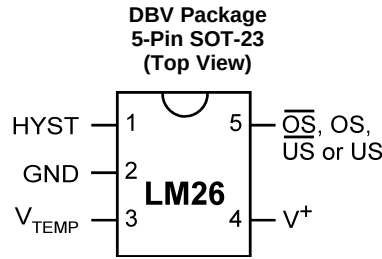
| Changes from Revision R (February 2013) to Revision S                                                                                                                                                                                                                                                                                                                                                    | Page     |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| • Added <i>Pin Configuration and Functions</i> section, <i>Handling Rating</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b> |
| • Removed <i>Part Number Template</i> table .....                                                                                                                                                                                                                                                                                                                                                        | <b>6</b> |
| • Removed <i>Temperature Trip Point Accuracy</i> table .....                                                                                                                                                                                                                                                                                                                                             | <b>6</b> |

| Changes from Revision Q (September 2011) to Revision R     | Page      |
|------------------------------------------------------------|-----------|
| • Changed layout of National Data Sheet to TI format ..... | <b>11</b> |

## 5 Device Comparison Table

| Order Number           |                          | Top Mark | Trip Point Setting | Output Function                                |
|------------------------|--------------------------|----------|--------------------|------------------------------------------------|
| Bulk Rail (1000 Units) | Tape & Reel (3000 Units) |          |                    |                                                |
| LM26CIM5-BPB           | LM26CIM5X-BPB            | TBPB     | -45°C              | Active-Low, Open-Drain, $\overline{US}$ output |
| LM26CIM5-DPB           | LM26CIM5X-DPB            | TDPB     | -25°C              | Active-Low, Open-Drain, $\overline{US}$ output |
| LM26CIM5-HHD           | LM26CIM5X-HHD            | THHD     | 0°C                | Active-High, Push-Pull, US output              |
| LM26CIM5-NPA           | LM26CIM5X-NPA            | TNPA     | 45°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-RPA           | LM26CIM5X-RPA            | TRPA     | 65°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-SHA           | LM26CIM5X-SHA            | TSHA     | 75°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-SPA           | LM26CIM5X-SPA            | TSPA     | 70°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-TPA           | LM26CIM5X-TPA            | TTPA     | 85°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-VHA           | LM26CIM5X-VHA            | TVHA     | 90°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-VPA           | LM26CIM5X-VPA            | TVPA     | 95°C               | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-XHA           | LM26CIM5X-XHA            | TXHA     | 100°C              | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-XPA           | LM26CIM5X-XPA            | TXPA     | 105°C              | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-YHA           | LM26CIM5X-YHA            | TYHA     | 110°C              | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-YPA           | LM26CIM5X-YPA            | TYPA     | 115°C              | Active-Low, Open-Drain, $\overline{OS}$ output |
| LM26CIM5-ZHA           | LM26CIM5X-ZHA            | TZHA     | 120°C              | Active-Low, Open-Drain, $\overline{OS}$ output |

## 6 Pin Configuration and Functions



### Pin Functions

| PIN              |                        | TYPE   | DESCRIPTION                                                                                                                                                       |
|------------------|------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NO.              | NAME                   |        |                                                                                                                                                                   |
| 1                | HYST                   | Input  | Hysteresis control, digital input; connect to GND for 10°C or V+ for 2°C                                                                                          |
| 2                | GND                    | Power  | Ground, connected to the back side of the die through lead frame; connect to system ground                                                                        |
| 3                | V <sub>TEMP</sub>      | Output | Analog output voltage proportional to temperature; leave floating or connect to a high impedance node.                                                            |
| 4                | V <sup>+</sup>         | Power  | Supply input; connect to 2.7 V to 5.5 V with a 0.1-μF bypass capacitor.                                                                                           |
| 5 <sup>(1)</sup> | $\overline{\text{OS}}$ | Output | Overtemperature Shutdown open-drain active low thermostat digital output; connect to controller interrupt, system/power supply shutdown; pullup resistor ≥ 10 kΩ  |
|                  | OS                     | Output | Overtemperature Shutdown push-pull active high thermostat digital output; connect to controller interrupt, system/power supply shutdown                           |
|                  | $\overline{\text{US}}$ | Output | Undertemperature Shutdown open-drain active low thermostat digital output; connect to controller interrupt, system/power supply shutdown; pullup resistor ≥ 10 kΩ |
|                  | US                     | Output | Undertemperature Shutdown push-pull active high thermostat digital output; connect to controller interrupt, system/power supply shutdown                          |

(1) Pin 5 functionality and trip point setting are programmed during LM26 manufacture.

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                                             |                |                          | MIN | MAX | UNIT |
|-------------------------------------------------------------|----------------|--------------------------|-----|-----|------|
| Input Voltage                                               |                |                          |     | 6   | V    |
| Input Current at any pin <sup>(2)</sup>                     |                |                          |     | 5   | mA   |
| Package Input Current <sup>(2)</sup>                        |                |                          |     | 20  | mA   |
| Package Dissipation at T <sub>A</sub> = 25°C <sup>(3)</sup> |                |                          |     | 500 | mW   |
| Soldering Information <sup>(4)</sup>                        | SOT-23 Package | Vapor Phase (60 seconds) |     | 215 | °C   |
|                                                             |                | Infrared (15 seconds)    |     | 220 |      |
| Storage Temperature, T <sub>stg</sub>                       |                |                          | -65 | 150 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) When the input voltage (V<sub>I</sub>) at any pin exceeds the power supply (V<sub>I</sub> < GND or V<sub>I</sub> > V<sup>+</sup>), the current at that pin should be limited to 5 mA. The 20-mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 5 mA to four. Under normal operating conditions the maximum current that pins 2, 4 or 5 can handle is limited to 5 mA each.
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>JMAX</sub> (maximum junction temperature), θ<sub>JA</sub> (junction to ambient thermal resistance) and T<sub>A</sub> (ambient temperature). The maximum allowable power dissipation at any temperature is P<sub>D</sub> = (T<sub>JMAX</sub> - T<sub>A</sub>) / θ<sub>JA</sub> or the number given in the *Absolute Maximum Ratings*, whichever is lower. For this device, T<sub>JMAX</sub> = 150°C. For this device the typical thermal resistance (θ<sub>JA</sub>) of the different package types when board mounted follow:
- (4) See the URL <http://www.ti.com/packaging> for other recommendations and methods of soldering surface mount devices.

## 7.2 ESD Ratings

|                    |                                        | VALUE                  | UNIT  |
|--------------------|----------------------------------------|------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge <sup>(1)</sup> | Human body model (HBM) | ±2500 |
|                    |                                        | Machine Model          | ±250  |
|                    |                                        |                        | V     |

- (1) The human body model is a 100-pF capacitor discharge through a 1.5-kΩ resistor into each pin. The machine model is a 200-pF capacitor discharged directly into each pin.

## 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                                     | MIN | MAX | UNIT |
|-------------------------------------------------------------------------------------|-----|-----|------|
| Specified Temperature Range (T <sub>MIN</sub> ≤ T <sub>A</sub> ≤ T <sub>MAX</sub> ) | –55 | 125 | °C   |
| Positive Supply Voltage (V <sup>+</sup> )                                           | 2.7 | 5.5 | V    |
| Maximum V <sub>OUT</sub>                                                            |     | 5.5 | V    |

- (1) *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. *Operating Ratings* indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the *Electrical Characteristics*. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                        | LM26         | UNIT |
|-------------------------------|----------------------------------------|--------------|------|
|                               |                                        | DBV (SOT-23) |      |
|                               |                                        | 5 PINS       |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance | 250          | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics

The following specifications apply for V<sup>+</sup> = 2.7 V<sub>DC</sub> to 5.5 V<sub>DC</sub>, and V<sub>TEMP</sub> load current = 0 μA unless otherwise specified. All limits apply for T<sub>A</sub> = T<sub>J</sub> = T<sub>MIN</sub> to T<sub>MAX</sub> unless otherwise specified.

| PARAMETER                                                                                                                                                                                 | TEST CONDITIONS                                                      | MIN <sup>(1)</sup> | TYP <sup>(2)</sup> | MAX <sup>(1)</sup> | UNIT  |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------|--------------------|--------------------|--------------------|-------|
| <b>TEMPERATURE SENSOR</b>                                                                                                                                                                 |                                                                      |                    |                    |                    |       |
| Trip Point Accuracy (Includes V <sub>REF</sub> , DAC, Comparator Offset, and Temperature Sensitivity errors)                                                                              | –55°C ≤ T <sub>A</sub> ≤ +110°C                                      |                    |                    | ±3                 | °C    |
|                                                                                                                                                                                           | T <sub>A</sub> = +120°C                                              |                    |                    | ±4                 | °C    |
| Trip Point Hysteresis                                                                                                                                                                     | HYST = GND                                                           |                    | 11                 |                    | °C    |
|                                                                                                                                                                                           | HYST = V <sup>+</sup>                                                |                    | 2                  |                    | °C    |
| V <sub>TEMP</sub> Output Temperature Sensitivity                                                                                                                                          |                                                                      |                    | –10.82             |                    | mV/°C |
| V <sub>TEMP</sub> Temperature Sensitivity Error to Equation:<br>V <sub>O</sub> = (–3.479 × 10 <sup>–6</sup> × (T – 30) <sup>2</sup> ) + (–1.082 × 10 <sup>–2</sup> × (T – 30)) + 1.8015 V | –30°C ≤ T <sub>A</sub> ≤ 120°C                                       |                    |                    | ±3                 | °C    |
|                                                                                                                                                                                           | –55°C ≤ T <sub>A</sub> ≤ 120°C, 4.5 V ≤ V <sup>+</sup> ≤ 5.5 V       |                    |                    | ±3                 | °C    |
|                                                                                                                                                                                           | T <sub>A</sub> = 30°C                                                |                    |                    | ±2.5               | °C    |
| V <sub>TEMP</sub> Load Regulation                                                                                                                                                         | Source ≤ 1 μA                                                        |                    | 0.070              |                    | mV    |
|                                                                                                                                                                                           | Sink ≤ 40 μA                                                         |                    |                    | 0.7                | mV    |
| V <sub>TEMP</sub> Line Regulation                                                                                                                                                         | +2.7 V ≤ V <sup>+</sup> ≤ +5.5 V,<br>–30°C ≤ T <sub>A</sub> ≤ +120°C |                    | –0.2               |                    | mV/V  |
| I <sub>S</sub> Supply Current                                                                                                                                                             | T <sub>A</sub> = 25°C                                                |                    | 16                 | 20                 | μA    |
|                                                                                                                                                                                           |                                                                      |                    |                    | 40                 |       |

- (1) Limits are guaranteed to TI's AOQL (Average Outgoing Quality Level).  
(2) Typicals are at T<sub>J</sub> = T<sub>A</sub> = 25°C and represent most likely parametric norm.

## Electrical Characteristics (continued)

The following specifications apply for  $V^+ = 2.7\text{ V}_{\text{DC}}$  to  $5.5\text{ V}_{\text{DC}}$ , and  $V_{\text{TEMP}}$  load current =  $0\text{ }\mu\text{A}$  unless otherwise specified. All limits apply for  $T_A = T_J = T_{\text{MIN}}$  to  $T_{\text{MAX}}$  unless otherwise specified.

| PARAMETER                |                                                 | TEST CONDITIONS                                                                                                                |                         | MIN <sup>(1)</sup>   | TYP <sup>(2)</sup> | MAX <sup>(1)</sup>   | UNIT |
|--------------------------|-------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-------------------------|----------------------|--------------------|----------------------|------|
| DIGITAL OUTPUT AND INPUT |                                                 |                                                                                                                                |                         |                      |                    |                      |      |
| I <sub>OUT(1)</sub>      | Logical 1 Output Leakage Current <sup>(3)</sup> | T <sub>A</sub> = 25°C                                                                                                          | V <sup>+</sup> = +5.0 V |                      | 0.001              | 1                    | μA   |
| V <sub>OUT(0)</sub>      | Logical 0 Output Voltage                        | I <sub>OUT</sub> = +1.2 mA and V <sup>+</sup> ≥ 2.7 V;<br>I <sub>OUT</sub> = +3.2 mA and V <sup>+</sup> ≥ 4.5 V <sup>(4)</sup> |                         |                      |                    | 0.4                  | V    |
| V <sub>OUT(1)</sub>      | Logical 1 Push-Pull Output Voltage              | I <sub>SOURCE</sub> = 500 μA, V <sup>+</sup> ≥ 2.7 V                                                                           |                         | 0.8 × V <sup>+</sup> |                    |                      | V    |
|                          |                                                 | I <sub>SOURCE</sub> = 800 μA, V <sup>+</sup> ≥ 4.5 V                                                                           |                         | V <sup>+</sup> − 1.5 |                    |                      | V    |
| V <sub>IH</sub>          | HYST Input Logical 1 Threshold Voltage          |                                                                                                                                |                         | 0.8 × V <sup>+</sup> |                    |                      | V    |
| V <sub>IL</sub>          | HYST Input Logical 0 Threshold Voltage          |                                                                                                                                |                         |                      |                    | 0.2 × V <sup>+</sup> | V    |

- (3) The  $1\text{-}\mu\text{A}$  limit is based on a testing limitation and does not reflect the actual performance of the part. Expect to see a doubling of the current for every  $15^\circ\text{C}$  increase in temperature. For example, the  $1\text{-nA}$  typical current at  $25^\circ\text{C}$  would increase to  $16\text{ nA}$  at  $85^\circ\text{C}$ .
- (4) Take care to include the effects of self heating when setting the maximum output load current. The power dissipation of the LM26 would increase by  $1.28\text{ mW}$  when  $I_{\text{OUT}} = 3.2\text{ mA}$  and  $V_{\text{OUT}} = 0.4\text{ V}$ . With a thermal resistance of  $250^\circ\text{C/W}$ , this power dissipation would cause an increase in the die temperature of about  $0.32^\circ\text{C}$  due to self heating. Self heating is not included in the trip point accuracy specification.

## 7.6 Typical Characteristics

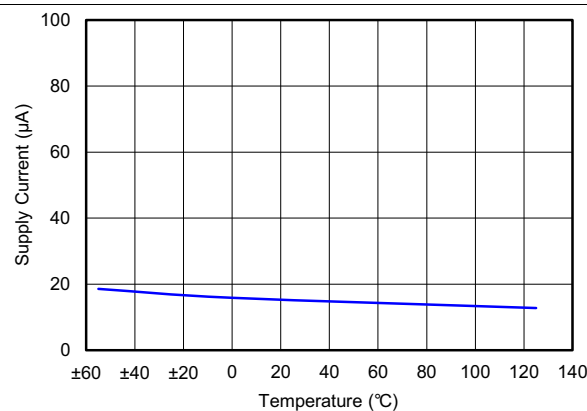


Figure 1. Power Supply Current Temperature Dependence

## 8 Detailed Description

### 8.1 Overview

The LM26 is a factory preset thermostat (temperature switch) that includes an integrated temperature sensor, reference voltage, DAC and comparator. The LM26 can be factory programmed to have a trip point anywhere in the range of  $-55^{\circ}\text{C}$  to  $+120^{\circ}\text{C}$ . The output functionality can also be changed during the manufacturing process, as described in the functional block diagrams. Available options include:

- $\overline{\text{OS}}$ : active low, open drain that indicates an over temperature shutdown event (most common)
- $\overline{\text{US}}$ : active low, open-drain that indicates an under temperature shutdown event
- OS: active high, push-pull that indicates an over temperature shutdown event
- US: active high, push-pull that indicates an under temperature shutdown event

The internal temperature sensor is brought out on the  $V_{\text{TEMP}}$  pin and can be used to determine the temperature that the LM26 is reading by monitoring with an ADC. It has a negative temperature coefficient (NTC) of approximately  $-10\text{mV}/^{\circ}\text{C}$ . This pin also allows after assembly PCB testing (see section [After Assembly PCB Testing](#) for more details).

The comparator hysteresis is selectable by the state of the HYST. Two values are available  $10^{\circ}\text{C}$  or  $2^{\circ}\text{C}$ . Comparator hysteresis is essential, as it prevents comparator output chattering when the temperature is at the comparator threshold set point (REF as shown in the functional block diagrams). Once the comparator trips the hysteresis function changes the comparator threshold (REF) level such that the output remains locked in the active state. The threshold is changed by either  $10^{\circ}\text{C}$  or  $2^{\circ}\text{C}$  as programmed by the state of the HYST pin.

### 8.2 Functional Block Diagrams

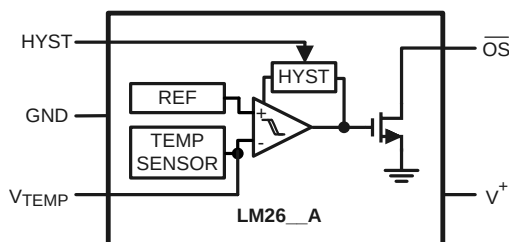


Figure 2. LM26\_\_A Output Pin Block Diagram

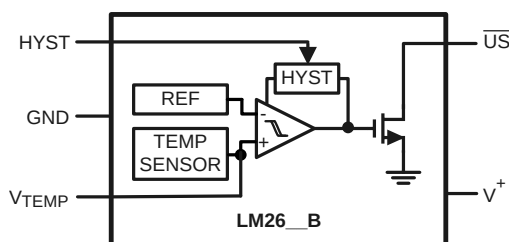


Figure 3. LM26\_\_B Output Pin Block Diagram

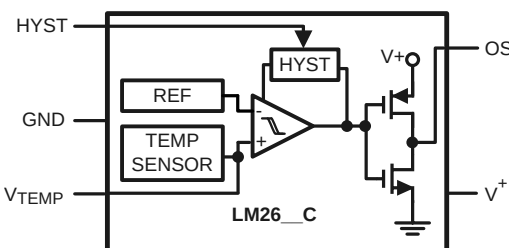
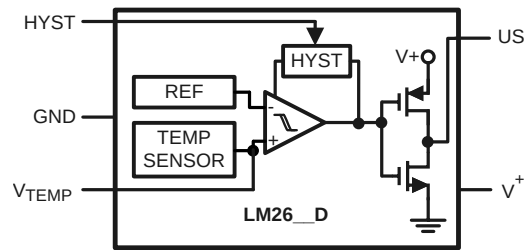


Figure 4. LM26\_\_C Output Pin Block Diagram

## Functional Block Diagrams (continued)



**Figure 5. LM26-\_\_D Output Pin Block Diagram**

## 8.3 Feature Description

### 8.3.1 Hysteresis

The HYST pin level sets the comparator hysteresis. Setting the HYST pin to GND selects 10°C hysteresis, while setting it to  $V^+$  selects 2°C. A series resistor can be used for protection purposes. The input leakage current of the pin is less than 10  $\mu\text{A}$ . The value of the resistor will depend on the value of  $V^+$  as well as the leakage current. For example with  $V^+ = 3.3\text{ V}$  the input threshold level for  $V_{IH} = 0.8 \times 3.3\text{ V} = 2.64\text{ V}$ , thus the voltage drop across the resistor should be less than 0.66 V. The 10- $\mu\text{A}$  input leakage current requires the resistor value to be less than 66 k $\Omega$ .

### 8.3.2 $V_{TEMP}$ Output

The  $V_{TEMP}$  output provides an output voltage that can be used to determine the temperature reading of the LM26. The temperature reading of the LM26 can be calculated using the equation:

$$V_O = (-3.47 \times 10^{-6} \times (T - 30)^2) + (1.082 \times 10^{-2} \times (T - 30)) + 1.8015\text{ V} \quad (1)$$

or

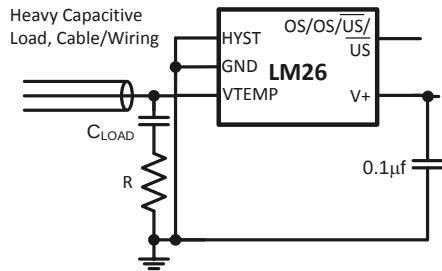
$$T = -1525.04 + \sqrt{2.4182 \times 10^6 + \frac{1.8015 - V_{TEMP}}{3.479 \times 10^{-6}}} \quad (2)$$

The  $V_{TEMP}$  output has very weak drive capability (1- $\mu\text{A}$  source, 40- $\mu\text{A}$  sink). So care should be taken when attaching circuitry to this pin. Capacitive loading may cause the  $V_{TEMP}$  output to oscillate. Simply adding a resistor in series as shown in [Figure 6](#) and [Figure 7](#) will prevent oscillations from occurring. To determine the value of the resistor follow the guidelines given in [Table 1](#). The same value resistor will work for either placement of the resistor. If an additional capacitive load is placed directly on the LM26 output, rather than across  $C_{LOAD}$ , it should be at least a factor of 10 smaller than  $C_{LOAD}$ .

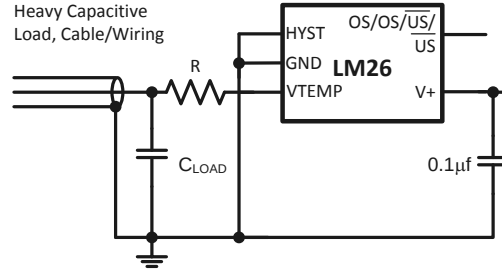
**Table 1. Resistive Compensation for Capacitive Loading of  $V_{TEMP}$**

| $C_{LOAD}$          | R ( $\Omega$ ) |
|---------------------|----------------|
| $\leq 100\text{pF}$ | 0              |
| 1nF                 | 8200           |
| 10nF                | 3000           |
| 100nF               | 1000           |
| $\geq 1\mu\text{F}$ | 430            |





**Figure 6. Resistor Placement for Capacitive-Loading Compensation of  $V_{TEMP}$  With R in Series With Capacitor**



**Figure 7. Resistor Placement for Capacitive-Loading Compensation of  $V_{TEMP}$  With R in Series With Signal Path**

## 8.4 Device Functional Modes

The LM26 after factory programming has two functional modes one with 2°C Hysteresis and the other with 10°C hysteresis as programmed by the level of the HYST pin. Selection of the level will depend on the system noise and the temperature transition rate.

### 8.4.1 After Assembly PCB Testing

The LM26's  $V_{TEMP}$  output allows after-assembly PCB testing by following a simple test procedure. Simply measuring the  $V_{TEMP}$  output voltage will verify that the LM26 has been assembled properly and that its temperature sensing circuitry is functional. The  $V_{TEMP}$  output has very weak drive capability that can be overdriven by 1.5mA. Therefore, one can simply force the  $V_{TEMP}$  voltage to cause the digital output to change state, thereby verifying that the comparator and output circuitry function after assembly. Here is a sample test procedure that can be used to test the LM26CIM5-TPA which has an 85°C trip point.

1. Turn on  $V^+$  and measure  $V_{TEMP}$ . Then calculate the temperature reading of the LM26 using the equation:

$$V_O = (-3.47 \times 10^{-6} \times (T - 30)^2) + (1.082 \times 10^{-2} \times (T - 30)) + 1.8015 \text{ V} \quad (3)$$

or

$$T = -1525.04 + \sqrt{2.4182 \times 10^6 + \frac{1.8015 - V_{TEMP}}{3.479 \times 10^{-6}}} \quad (4)$$

2. Verify that the temperature measured in step one is within ( $\pm 3^\circ\text{C}$  + error of reference temperature sensor) of the ambient/board temperature. The ambient/board temperature (reference temperature) should be measured using an extremely accurate calibrated temperature sensor.
3.
  - (a) Observe that  $\overline{OS}$  is high.
  - (b) Drive  $V_{TEMP}$  to ground.
  - (c) Observe that  $\overline{OS}$  is now low.
  - (d) Release the  $V_{TEMP}$  pin.
  - (e) Observe that  $\overline{OS}$  is now high.
4.
  - (a) Observe that  $\overline{OS}$  is high.
  - (b) Drive  $V_{TEMP}$  voltage down gradually.
  - (c) When  $\overline{OS}$  goes low, note the  $V_{TEMP}$  voltage.
  - (d)  $V_{TEMPTrig} = V_{TEMP}$  at  $\overline{OS}$  trigger (HIGH->LOW)
  - (e) Calculate Trig using [Equation 2](#).
5.
  - (a) Gradually raise  $V_{TEMP}$  until  $\overline{OS}$  goes HIGH. Note  $V_{TEMP}$ .
  - (b) Calculate  $T_{HYST}$  using [Equation 2](#).

## 9 Application and Implementation

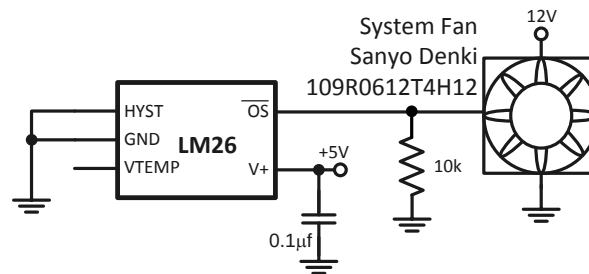
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The LM26 thermostat (temperature switch) can be used in applications such as microprocessor thermal management, appliances, fan control, industrial process control, power supplies for system protection, fan speed adjust or plain temperature monitoring.

### 9.2 Typical Application



**Figure 8. Two-Speed Fan Speed Control**

#### 9.2.1 Design Requirements

The requirement is to change speed for a fan to maximum at 45°C with an accuracy of

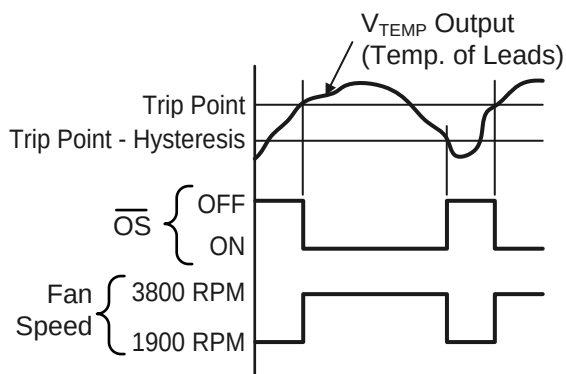
**Table 2. Design Parameters**

| DESIGN PARAMETER                                            | EXAMPLE VALUE |
|-------------------------------------------------------------|---------------|
| Min Fan Speed                                               | 1900 RPM      |
| Max Fan Speed                                               | 3800 RPM      |
| Temperature Threshold To Switch From Min Speed to Max Speed | 45°C          |
| Threshold accuracy                                          | ±3°C          |

#### 9.2.2 Detailed Design Procedure

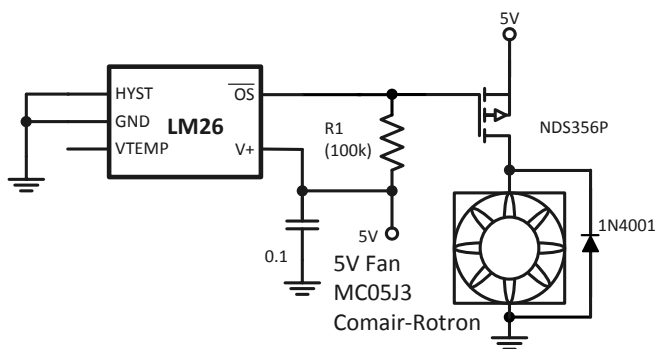
The design procedure is simple. A fan was selected that has the capability to be controlled by an external NTC thermistor. The recommended NTC thermistor adjusts the fan speed to maximum at 40°C. The LM26 meets the threshold accuracy requirements for temperature control of the fan speed and allows setting the max speed temperature threshold higher as required to 45°C. The resistance of the thermistor for the min fan speed is 6.8 kΩ. Since thermistors have a negative temperature coefficient (NTC), 10 kΩ was chosen to ensure that the fan is at min speed when the LM26 OS is off. When the OS output goes low at 45°C it simulates the low thermistor resistance at higher temperatures thus setting fan to max speed.

## 9.2.3 Application Curve

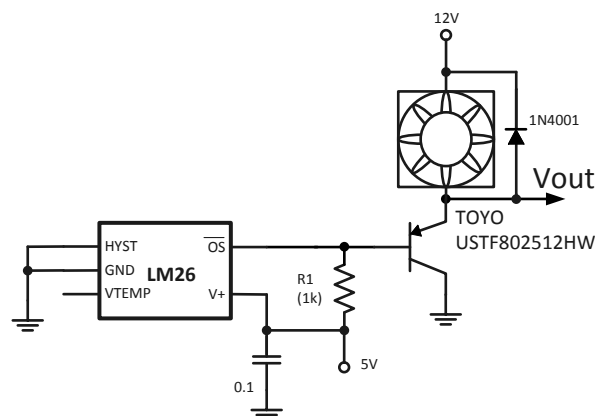


**Figure 9. Temperature Effect on Fan Speed**

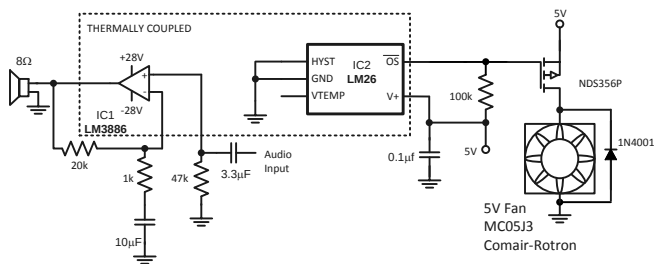
## 9.3 System Examples



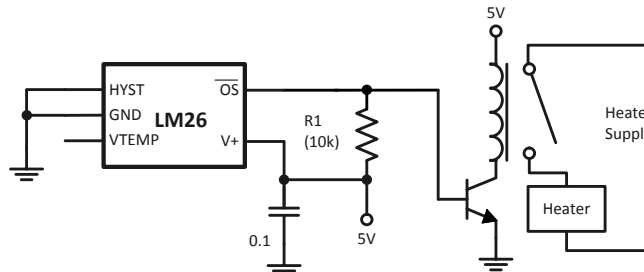
**Figure 10. Fan High-Side Drive**



**Figure 11. Fan Low-Side Drive**



**Figure 12. Audio Power Amplifier Thermal Protection**



**Figure 13. Simple Thermostat**

## 10 Power Supply Recommendations

The LM26 has excellent power supply noise rejection. Listed below is a variety of signals used to test the LM26 power supply rejection. False triggering of the output was not observed when these signals were coupled into the V+ pin of the LM26.

- square wave 400 kHz, 1 Vp-p
- square wave 2 kHz, 200 mVp-p
- sine wave 100 Hz to 1 MHz, 200 mVp-p

Testing was done while maintaining the temperature of the LM26 one degree centigrade away from the trip point with the output not activated.

## 11 Layout

### 11.1 Layout Guidelines

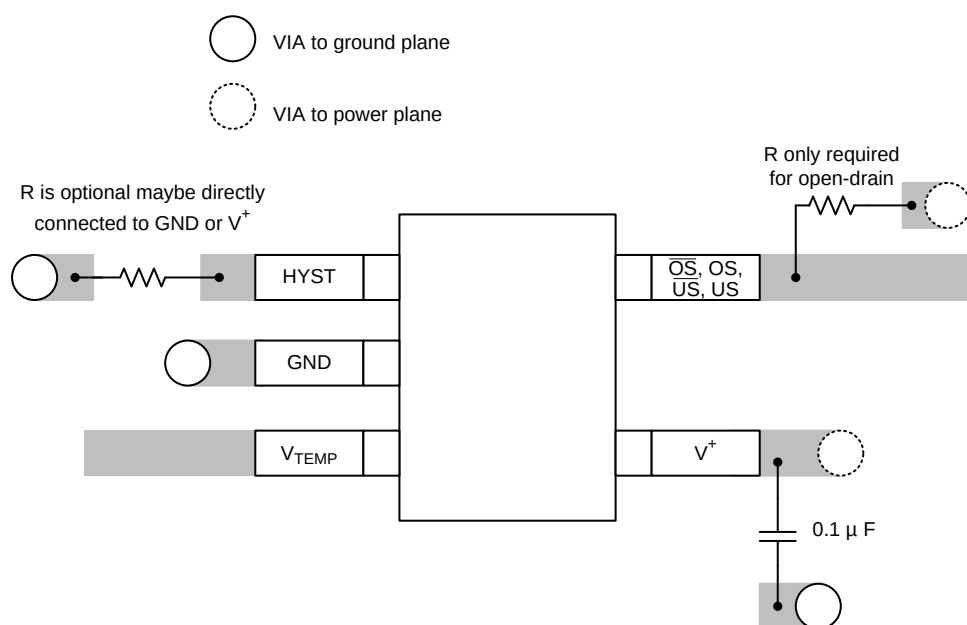
The LM26 can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface. The temperature that the LM26 is sensing will be within about  $+0.06^{\circ}\text{C}$  of the surface temperature to which the LM26's leads are attached to.

This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature measured would be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity, the backside of the LM26 die is directly attached to the GND pin (pin 2). The temperatures of the lands and traces to the other leads of the LM26 will also affect the temperature that is being sensed.

Alternatively, the LM26 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM26 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paints or dips are often used to ensure that moisture cannot corrode the LM26 or its connections.

### 11.2 Layout Example



**Figure 14. LM26 Typical Layout**

### 11.3 Thermal Considerations

The junction to ambient thermal resistance ( $R_{\theta JA}$ ) is the parameter used to calculate the rise of a part's junction temperature due to its power dissipation. For the LM26 the equation used to calculate the rise in the die junction temperature is as follows:

$$T_J = T_A + \Theta_{JA} (V^+ - V_{TEMP}) I_{L\_TEMP} + V_{DO} I_{DO}$$

where

- $T_A$  is the ambient temperature,  $V^+$  is the power supply voltage
  - $I_Q$  is the quiescent current,  $I_{L\_TEMP}$  is the load current on the  $V_{TEMP}$  output
  - $V_{DO}$  is the voltage on the digital output
  - and  $I_{DO}$  is the load current on the digital output
- (5)

Since the LM26's junction temperature is the actual temperature being measured, care should be taken to minimize the load current that the LM26 is required to drive.

[Table 3](#) summarizes the thermal resistance for different conditions and the rise in die temperature of the LM26 without any loading on  $V_{TEMP}$  and a 10-k $\Omega$  pullup resistor on an open-drain digital output with a 5.5-V power supply.

**Table 3. Thermal resistance ( $R_{\theta JA}$ ) and Temperature Rise Due to Self Heating ( $T_J - T_A$ )**

|            | SOT-23 5 pin<br>no heat sink |                     |
|------------|------------------------------|---------------------|
|            | $R_{\theta JA}$<br>(°C/W)    | $T_J - T_A$<br>(°C) |
| Still Air  | 250                          | 0.11                |
| Moving Air | TBD                          | TBD                 |

## 11.4 Part Number Template

The series of digits labeled xyz in the part number LM26CIM-xyz, describe the set point value and the function of the output as follows:

The place holders xy describe the set point temperature as shown in the following table.

| x (10x) | y (1x) | Temperature (°C) |
|---------|--------|------------------|
| A       | -      | -5               |
| B       | -      | -4               |
| C       | -      | -3               |
| D       | -      | -2               |
| E       | -      | -1               |
| F       | -      | -0               |
| H       | H      | 0                |
| J       | J      | 1                |
| K       | K      | 2                |
| L       | L      | 3                |
| N       | N      | 4                |
| P       | P      | 5                |
| R       | R      | 6                |
| S       | S      | 7                |
| T       | T      | 8                |
| V       | V      | 9                |
| X       | -      | 10               |
| Y       | -      | 11               |
| Z       | -      | 12               |

The value of z describes the assignment/function of the output as shown in the following table:

| Active-Low/High | Open-Drain/ Push-Pull | $\overline{OS}/US$ | Value of z | Digital Output Function                        |
|-----------------|-----------------------|--------------------|------------|------------------------------------------------|
| 0               | 0                     | 0                  | A          | Active-Low, Open-Drain, $\overline{OS}$ output |
| 0               | 0                     | 1                  | B          | Active-Low, Open-Drain, $\overline{US}$ output |
| 1               | 1                     | 0                  | C          | Active-High, Push-Pull, OS output              |
| 1               | 1                     | 1                  | D          | Active-High, Push-Pull, US output              |

For example:

- the part number LM26CIM5-TPA has  $T_{OS} = 85^{\circ}\text{C}$ , and programmed as an active-low open-drain overtemperature shutdown output.
- the part number LM26CIM5-FPD has  $T_{US} = -5^{\circ}\text{C}$ , and programmed as an active-high, push-pull undertemperature shutdown output.

Active-high open-drain and active-low push-pull options are available, please contact Texas Instruments for more information.

## 12 Device and Documentation Support

### 12.1 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.2 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LM26CIM5-BPB/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TBPB                |
| LM26CIM5-BPB/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TBPB                |
| <a href="#">LM26CIM5-DPB/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TDPB                |
| <a href="#">LM26CIM5-HHD/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | THHD                |
| <a href="#">LM26CIM5-NPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TNPA                |
| <a href="#">LM26CIM5-PHA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TPHA                |
| <a href="#">LM26CIM5-RPA/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | Call TI   Sn                         | Level-1-260C-UNLIM                | -55 to 125   | TRPA                |
| LM26CIM5-RPA/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | Call TI                              | Level-1-260C-UNLIM                | -55 to 125   | TRPA                |
| <a href="#">LM26CIM5-SHA/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TSHA                |
| LM26CIM5-SHA/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TSHA                |
| <a href="#">LM26CIM5-SPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TSPA                |
| <a href="#">LM26CIM5-TPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TTPA                |
| <a href="#">LM26CIM5-VHA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TVHA                |
| <a href="#">LM26CIM5-VPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TVPA                |
| <a href="#">LM26CIM5-XHA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TXHA                |
| <a href="#">LM26CIM5-XPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TXPA                |
| <a href="#">LM26CIM5-YHA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TYHA                |
| <a href="#">LM26CIM5-YPA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TYPA                |
| LM26CIM5-YPA/NOPB.B                | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| LM26CIM5-ZHA                       | NRND          | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | No          | SNPB                                 | Level-1-260C-UNLIM                | -55 to 125   | TZHA                |
| LM26CIM5-ZHA.A                     | NRND          | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | No          | SNPB                                 | Level-1-260C-UNLIM                | -55 to 125   | TZHA                |
| <a href="#">LM26CIM5-ZHA/NOPB</a>  | Obsolete      | Production           | SOT-23 (DBV)   5 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | TZHA                |
| <a href="#">LM26CIM5X-DPB/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TDPB                |
| LM26CIM5X-DPB/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TDPB                |
| LM26CIM5X-DPB/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-HHD/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | THHD                |
| LM26CIM5X-HHD/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | THHD                |
| LM26CIM5X-HHD/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-NPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TNPA                |



| Orderable part number              | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| LM26CIM5X-NPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TNPA                |
| LM26CIM5X-NPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-PHA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TPHA                |
| LM26CIM5X-PHA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TPHA                |
| LM26CIM5X-PHA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-SPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TSPA                |
| LM26CIM5X-SPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TSPA                |
| LM26CIM5X-SPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-TPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TTPA                |
| LM26CIM5X-TPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TTPA                |
| LM26CIM5X-TPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-VHA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TVHA                |
| LM26CIM5X-VHA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TVHA                |
| LM26CIM5X-VHA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-VPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TVPA                |
| LM26CIM5X-VPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TVPA                |
| LM26CIM5X-VPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-XHA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TXHA                |
| LM26CIM5X-XHA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TXHA                |
| <a href="#">LM26CIM5X-XPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TXPA                |
| LM26CIM5X-XPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TXPA                |
| LM26CIM5X-XPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-YHA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TYHA                |
| LM26CIM5X-YHA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TYHA                |
| LM26CIM5X-YHA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-YPA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TYP A               |
| LM26CIM5X-YPA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TYP A               |
| LM26CIM5X-YPA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |
| <a href="#">LM26CIM5X-ZHA/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TZHA                |
| LM26CIM5X-ZHA/NOPB.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -55 to 125   | TZHA                |
| LM26CIM5X-ZHA/NOPB.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | -           | Call TI                              | Call TI                           | -55 to 125   |                     |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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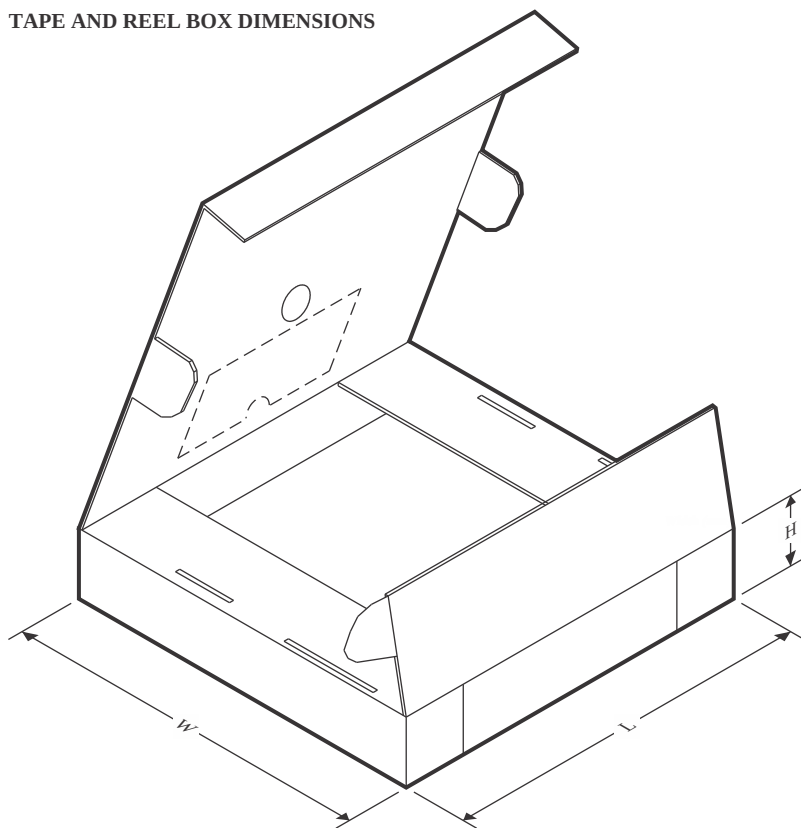
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM26CIM5-BPB/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5-RPA/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5-SHA/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-DPB/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-HHD/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-NPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-PHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-SPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-TPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-VHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-VPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-XHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-XPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-YHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-YPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM26CIM5X-ZHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM26CIM5-BPB/NOPB  | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5-RPA/NOPB  | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5-SHA/NOPB  | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-DPB/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-HHD/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-NPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-PHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-SPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-TPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-VHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-VPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-XHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-XPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-YHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-YPA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LM26CIM5X-ZHA/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |

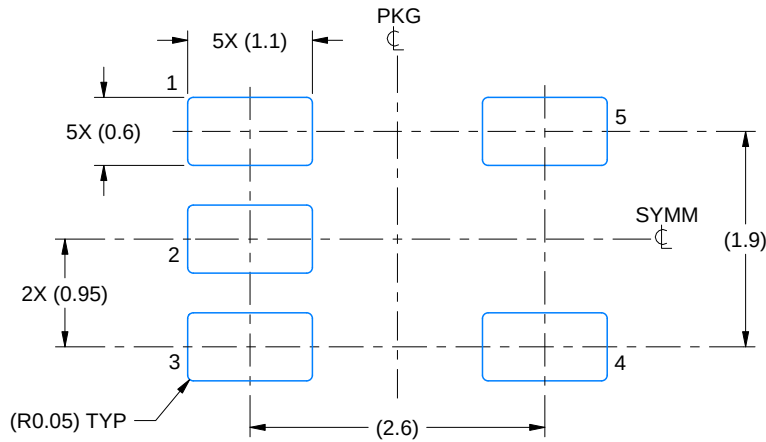


# EXAMPLE BOARD LAYOUT

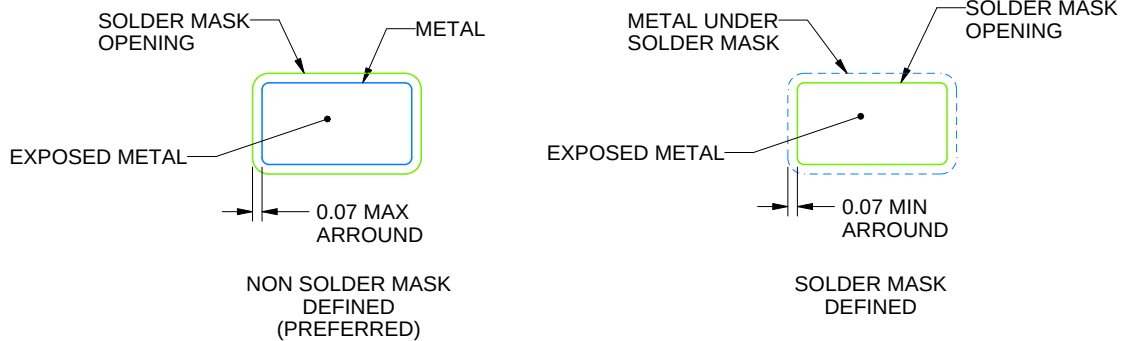
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

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NOTES: (continued)

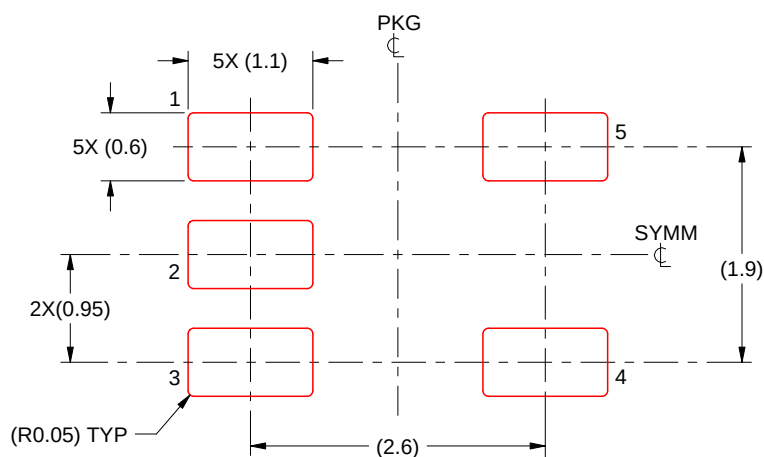
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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